Milmonomillininininin hilomil

|||||

J0 Scale 1:2

Author: Nathan Monson

Source: Atari

Description: Jaguar Edge *Size:* 3157 x 302 mil

DIN(a)	PAD			
PIN(s)	TYPE	SHAPE	SIZE	HOLE
1-2	SMT	Rect	302 x 30 mil	
3	SMT	Rect	240 x 30 mil	
4	SMT	Rect	302 x 30 mil	
5-17	SMT	Rect	240 x 30 mil	
18-21	SMT	Rect	302 x 30 mil	
22	SMT	Rect	240 x 30 mil	
23	SMT	Rect	302 x 30 mil	
24-25	SMT	Rect	240 x 30 mil	
26	SMT	Rect	302 x 30 mil	
27-30	SMT	Rect	240 x 30 mil	
31	SMT	Rect	302 x 30 mil	
32-40	SMT	Rect	240 x 30 mil	
41	SMT	Rect	302 x 30 mil	
42	SMT	Rect	240 x 30 mil	
43	SMT	Rect	302 x 30 mil	
44	SMT	Rect	240 x 30 mil	
45	SMT	Rect	302 x 30 mil	
46-50	SMT	Rect	240 x 30 mil	
51-52	SMT	Rect	302 x 30 mil	

XSON8 Scale 2:1

Author: James Jones

Source: NXP AN10343 MicroPak Soldering Information Rev. 2 Description: XSON8 SOT833-1 plastic extremely thin small outline

package, no leads Size: 2.6 x 2.2 mm

DIN(c)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1-4	SMT	Rect	0.3 x 0.95 mm		
5	SMT	Rect	0.3 x 1 mm		
6-8	SMT	Rect	0.3 x 0.95 mm		

TestPoint

Author: Ivex

Source: SURFACE MOUNT DESIGN AND LAND PATTERN

STANDARD SUBSECTION 8.2 (PAGE 3 OF 4)

Size: 1.2 x 1.2 mm

DIN(a)	PAD			
PIN(s)	TYPE	SHAPE	SIZE	HOLE
1	SMT	Round	1.2 mm	

HOLE_90_NOPAD

Size: 129 x 129 mil

DIN(a)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1	TH	Round	129 mil	90 mil	

VQ-64

Author: Nathan Monson

Source: Xilinx

Description: XC9572XL VQ64

Size: 12.9 x 12.9 mm

ſ	DIN(a)	PAD				
	PIN(s)	TYPE	SHAPE	SIZE	HOLE	
	1-64	SMT	Rect	1.5 x 0.3 mm		

F55CAP

Author: Nathan Monson

Source: Nippon Alchip Datasheet

Description: SMT Electrolytic Cap (F55-sized)

Size: 6.7 x 8.72 mm

DIN(a)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1-2	SMT	Rect	3.15 x 1.6 mm		

6X1HDR-100

Author: Ivex

Source: PRINTED CIRCUIT DESIGN METHODS PAGE 411

Size: 600 x 100 mil

PIN(s)	PAD				
PIN(S)	TYPE	SHAPE	SIZE	HOLE	
1-6	TH	Round	60 mil	39 mil	

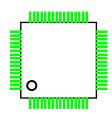
Scale 2:1

•









Scale 2:1



Scale 2:1



USBMINI

Author: Nathan Monson

Source: Molex 54819 Design Doc Description: USB Mini A/B

Size: 11.9 x 9.7 mm

DIN(g)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1-5	SMT	Rect	2.25 x 0.5 mm		
6-7	SMT	Rect	6.8 x 2.05 mm		





USBA

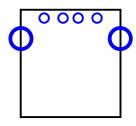
Author: Nathan Monson Source: Berg Electronics

Description: 87250 Type A Receptacle

Size: 16.44 x 14.2 mm

DIN(c)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1-4	TH	Round	1.5 mm	0.99 mm	
5-6	TH	Round	3.3 mm	2.3 mm	





MSOP8

Author: Nathan Monson Source: PCB Libraries

Description: TI TPS-2149 Regulator

Size: 3 x 5.8 mm

~ 1		_	
Scal	е	٠,٠	1



DIN(a)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1-8	SMT	Rect	1.4 x 0.45 mm		
9	SMT	Rect	1.85 x 1.85 mm		

TSOP48

Author: Nathan Monson

Source: PCB Libraries JEDEC MO-142DD

Description: TSOP 48 Flash ROM

Size: 12.1 x 21.35 mm

DIN(g)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1-48	SMT	Rect	1.45 x 0.3 mm		

Scale 1:1



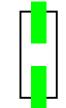
CSM-7-DN

Author: Nathan Monson Source: csm-7-dn.pdf

Description: ECS SMD Crystal

Size: 4.8 x 14 mm

DIN(a)	PAD				
PIN(s)	TYPE	SHAPE	SIZE	HOLE	
1-2	SMT	Rect	5.5 x 2 mm		



Scale 2:1

TSOP100

Author: Nathan Monson

Source: CY4640 board layout

Description: CY7C67300 Footprint

Size: 16.9 x 16.9 mm

PIN(s)	PAD				
	TYPE	SHAPE	SIZE	HOLE	
1-100	SMT	Rect	1.5 x 0.3 mm		

Scale 2:1

